

小型铝电解电容器 MINIATURE ALUMINUM ELECTROLYTIC CAPACITORS

◆编带规格/TAPING SPECIFICATIONS

◆纵向引线形 (04形) 编带形状尺寸图/DIMENSIONS





◆规格表/SPECIFICATION TABLE

5mm Height 7mm or 7.5mm Height 记号 项 目 允许差 Code Items $\phi 4 \sim \phi 6.3 \phi 4 \sim \phi 6.3$ Tolerance $\phi 4 \sim \phi 8$ φ8 引线加工记号 Τ5 ΤZ Τ5 ΤZ TA Τ7 Taping code 形状尺寸图 Fig.2 Fig.1 Fig.2 Fig.1 Fig.1 Fig.2 Applicable Fig. No. 引线直径 ϕd 0.45 0.45 ± 0.05 Dia. of lead 主体高度 L 6.5 8.5 MAX Height of body 主体间距 Р 12.7 12.7 ± 1.0 Distance from center to center of next body 穿孔间距 P₀ 12.7 12.7 ±0.2 Distance from center to center of next driving hole 穿孔与引线间距 P₁ 3.85 5.1 3.85 5.1 4.6 ± 0.5 Distance between center of driving hole and lead 穿孔与主体间距 P₂ 6.35 6.35 ± 1.0 Distance between center of driving hole and body 引线间距 +0.8 F 2.5 5.0 2.5 5.0 3.5 Pitch of lead -0.2衬纸宽度 W 18.0 18.0 ±0.3 Width of mounting tape 胶带宽度 Wo MIN 5.0 5.0 Width of adhesive tape 穿孔与衬纸间距 W1 9.0 9.0 ±0.5 Distance between center of driving hole and mounting tape edge 胶带与衬纸间距 W₂ 1.5 1.5 MAX Max. allowable distance between mounting and adhesive tape edges 主体下方位置 Н 17.5 17.5 20.0 ± 0.75 Distance between center of driving hole and bottom of body 引线弯曲高度 16.0 16.0 ±0.5 Hο Distance between center of driving hole and clinch part of lead 引线头 0.5 0.5 MAX L1 End of lead 穿孔直径 φ **D**0 4.0 ±0.2 4.0 Dia. of driving hole 主体倾斜度 MAX ∆h 1.0 1.0 Off alignment of body top 主体倾斜度 ∆p 1.0 1.0 MAX Off alignment of body top 编带总厚度 t 0.6 0.6 ± 0.3 Sum of thickness for mounting and adhesive tape without lead dia 包装数量(个) 2000 (*φ* 8:1000) Quantity (pcs)

(mm)



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(mm)

◆规格表/SPECIFICATION TABLE

9mm or more Height 记号 允许差 项 目 Items Code $\phi 5, \phi 6.3$ φ8 φ10 φ **12.5** φ**16** φ**18** Tolerance 引线加工记号 T1 ΤA TA T7 T8 G4 GC Taping code 形状尺寸图 Fig.2 Fig.2 Fig.1 Fig.1 Fig.2 Fig.2 Fig.3 Applicable Fig. No. 引线直径 ϕd 0.5 0.6 0.8 ± 0.05 Dia. of lead 主体高度 L 13.0 22.0 30.0 42.0 MAX Height of body 主体间距 Ρ 12.7 15.0 30.0 ±1.0 Distance from center to center of next body 穿孔间距 P₀ 12.7 15.0 15.0 ± 0.3 ±0.2 Distance from center to center of next driving hole 穿孔与引线间距 P₁ 5.1 3.85 4.6 3.85 5.0 3.75 ± 0.5 Distance between center of driving hole and lead 穿孔与主体间距 P₂ 6.35 7.5 ±1.0 Distance between center of driving hole and body +0.8 引线间距 F 3.5 5.0 ± 0.8 7.5±0.8 2.5 5.0 -0.2Pitch of lead 衬纸宽度 W 18.0 ±0.3 Width of mounting tape 胶带宽度 W_0 5.0 MIN Width of adhesive tape 穿孔与衬纸间距 ±0.5 W1 9.0 Distance between center of driving hole and mounting tape edge 胶带与衬纸间距 1.5 W2 MAX Max. allowable distance between mounting and adhesive tape edges 主体下方位置 $18.5^{+0.75}_{-0.5}$ ±0.75 20.0 Н 18.5 Distance between center of driving hole and bottom of body 引线弯曲高度 H٥ 16.0 ±0.5 Distance between center of driving hole and clinch part of lead 引线头 0.5 MAX Lı End of lead 穿孔直径 φDo 4.0 ±0.2 Dia. of driving hole 主体倾斜度 MAX ∆h 1.0 Off alignment of body top 主体倾斜度 ∆p 1.0 MAX Off alignment of body top 编带总厚度 ± 0.3 t 0.6 Sum of thickness for mounting and adhesive tape without lead dia 包装数量(个) 2000 1000 500 250 Quantity (pcs)



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◆引线加工规格 / LEAD CUTTING FORMING SPECIFICATIONS

为了使产品在印刷电路板上安装方便,我公司对产品引线有以下加工类型:引线成型,引线切脚,基板自立型特殊加工(爪式引线成型)。 Rubycon provides lead-formed and lead-cut products to facilitate mounting on printed circuit boards, as well as products with leads specially processed (kink formed) for self supporting insertions to printed circuit boards.

